



Dimensions

Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	2.8mm +/-0.3mm
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
K	1.8mm TYP

Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	2800

General Information

Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, Molded, High Temperature
Features	High Temperature, Automotive
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200
AEC-Q200	Yes
Notes	Obsolete.

Specifications

Capacitance	15 uF
Capacitance Tolerance	10%
Voltage DC	35 VDC (85C), 27.89 VDC (125C), 23.45 VDC (150C)
Temperature Range	-55/+150°C
Rated Temperature	85°C
Dissipation Factor	6%
Failure Rate	N/A
ESR	0.7 Ohms (100kHz)
Ripple Current	462.9 mAmps (25C), 416.6 mAmps (85C), 185.2 mAmps (125C)
Leakage Current	5.3 uA